

86740 Nickel/Copper

Fabric Tape



NI/CU POLYESTER CONDUCTIVE FABRIC TAPE

Laird's Conductive Fabric Tape 86740 offers exceptional conformability and conductivity for dynamic flex applications. It is constructed of nickel/copper metallized fabric with a conductive pressure sensitive adhesive (PSA). This reliable tape design provides outstanding shielding performance while offering superior abrasion and corrosion resistance under high dynamic flex conditions. The 86740 is a halogen free product and can be supplied in tape or further customized to application by die-cutting or hole punching.

FEATURES **FROHS**

- RoHS compliant
- Halogen-free per IEC-61249-2-21 standard
- Low surface resistivity of $< 0.05 \Omega/\Box$ provides excellent conductivity
- Shielding effectiveness of >75 dB across a wide spectrum of frequencies

MARKETS



- Cabinet applications
- LCD and Plasma TV
- Medical equipment
- Servers
- Printers
- Laptop computers

ltem	Unit	Value	Test Method
Thickness	mm	0.075 mm ± 0.01	-
Peel Adhesion	Kgf / 25 mm	>0.8	PSTC 101*
Shear Adhesion			
at R.T.	Hrs	>72	PSTC 107#
at 80°C	Hrs	>5	PSTC 107#
Tensile Strength	Kgf / 25 mm	>7.5	
Operation Temperature	°C	0-80	
Surface Resistivity (Fabric Side)	Ω/□	<0.05	ASTM F390
Z-axial Resistance	Ω	<0.03	
Shielding Effectiveness+			ASTM D4935
at 100 MHz	dB	75	
at 1GHz	dB	80	
Package Dimensions (Max. Width: 1000 mm)	М	W: Dimension by Customer Spec L: Standard Length of 20 M	
Shelf Life (Under 23°C/65% R.H.)		Six Months	

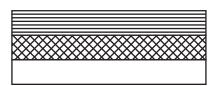
^{*:}Test Method A, dwell time 30 min. #:Contact area 25 mm by 25 mm +:Typical value

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COMPOSITION OF PRODUCT



- Conductive layer (metallized fabric)
- Adhesive layer (acrylic conductive pressure sensitive adhesive)
- Release paper

APPLICATION TECHNIQUES

- 1. Bond strength is dependent upon the amount of adhesive-to-surface contact developed. Firm application pressure develops better adhesive contact & thus improves bond strength.
- To obtain optimum adhesion, the bonding surfaces must be clean, dry and well unified. A typical surface cleaning solvent is isopropyl alcohol. Use proper safety precautions for handling solvents.
- 3. Ideal tape application temperature range is 21°C to 38°C. Initial tape application to surfaces at temperatures below 10°C is not recommended because the adhesive becomes too firm to adhere readily. However, once properly applied, low temperature holding is generally satisfactory.

Mouser Electronics

Authorized Distributor

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Laird Performance Materials:

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